1795



PATENT APPLICATION

## IN THE U.S. PATENT AND TRADEMARK OFFICE

November 8, 2007

Applicants: Katsuyuki TSUCHIDA et al

For: COPPER ELECTROI

COPPER ELECTROLYTIC SOLUTION CONTAINING AS ADDITIVE COMPOUND HAVING SPECIFIC SKELETON, AND ELECTROLYTIC COPPER FOIL MANUFACTURED THEREWITH

Serial No.: 10/588 686 Group: 1795

Confirmation No.: 9917

Filed: August 7, 2006 Examiner: Wong
International Application No.: PCT/JP2005/022662

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Atty. Docket No.: 4700.P0335US

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the provisions of Rules 1.97(e)(1) and 1.98, enclosed herewith is a copy of a Korean Office Action, Form PTO-1449 and the references cited thereon. Accordingly, further comment at this point in time should not be necessary.

I hereby certify that each item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.

Further consideration is respectfully solicited.

Respectfully submitted,

Terryence F. Chapman

TFC/smd

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		_		24 949
	Heon Jekal *limited recognition number	Reg.	No.	L0379*

Encl: Copy of Korean Office Action dated August 30, 2007 Form PTO-1449 and references cited thereon Postal Card

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## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 8, 2007.

Terryenge F. Chapmar

110.10/07